| PCN Number: | | 20160128000 | | | | | PCN Date: | | 2/09/2016 | | |
|---|-------------|--------------|--------------|--------------------|---|------------|-------------------|------------------|------------|--|--|
| Title: Datasheet for TPS63020-Q1 | | | | | | | | | | | |
| Custome | er Contact: | PCN Manager | | | | | ot: | Quality Services | | | |
| Change | Туре: | | | | | | | | | | |
| Assembly Site | | | Design | | | Wafer | er Bump Site | | | | |
| Asse | | \boxtimes | Data Sheet | Wafer Bump Mater | | | | p Material | | | |
| Assembly Materials | | | | Part number change | |] [| Wafer | fer Bump Process | | | |
| Mechanical Specification | | | | Test Site | |] [| Wafer | er Fab Site | | | |
| Pack | Labeling | | Test Process | |] | | | Materials | | | |
| | | | | | | Wafer | Wafer Fab Process | | | | |
| Notification Details | | | | | | | | | | | |
| Description of Change: | | | | | | | | | | | |
| Texas Instruments Incorporated is announcing an information only notification. | | | | | | | | | | | |
| The product datasheet(s) is updated as seen in the change revision history below: | | | | | | | | | | | |
| TEXAS | | | | | | | | | | | |
| INSTRUMENTS | | | | | | | | | | | |
| TPS63020-Q1 SLVSD52A – OCTOBER 2015–REVISED JANUARY 2016 www.ti.com | | | | | | | | | www.ti.com | | |
| WWW.U.COIII | | | | | | | | | | | |
| Changes from Original (October 2015) to Revision A Page | | | | | | | | | | | |
| Changed Feature list item Device CDM ESD Classification Level from C4B to C4A | | | | | | | | | | | |
| Changed device number to TPS63020-Q1 in the graphic entities throughout data sheet | | | | | | | | | | | |
| Deleted Eff. vs Input Volt. graph with Power Save Disabled for TPS63021 - not applicable | | | | | | | | | | | |
| | | | | | | | | | | | |
| Device I | Family | Change From: | | | | Change To: | | | | | |
| TPS63020-Q1 | | | SLVSD52 | | | | SLVSD52A | | | | |
| | | | | | | | | | | | |
| These changes may be reviewed at the datasheet links provided. | | | | | | | | | | | |
| http://www.ti.com/product/tps63020-q1 | | | | | | | | | | | |
| | | | | | | | | | | | |
| Reason for Change: | | | | | | | | | | | |
| To more accurately reflect device characteristics. | | | | | | | | | | | |
| Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): | | | | | | | | | | | |
| No anticipated impact. This is a specification change announcement only. There are no changes to the actual device. | | | | | | | | | | | |
| Changes to product identification resulting from this PCN: | | | | | | | | | | | |
| None. | | | | | | | | | | | |
| Product | Affected: | | | | | | | | | | |
| TPS63020QDSJTQ1 | | | | | | | | | | | |
| 11303020QD311Q1 | | | | | | | | | | | |

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

| Location | E-Mail |
|--------------|--------------------------------|
| USA | PCNAmericasContact@list.ti.com |
| Europe | PCNEuropeContact@list.ti.com |
| Asia Pacific | PCNAsiaContact@list.ti.com |
| Japan | PCNJapanContact@list.ti.com |